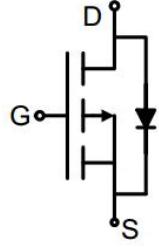
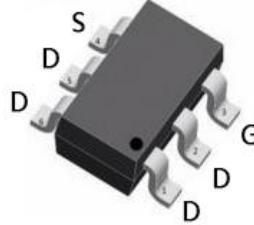


P-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The G500P03LL uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} -30V ● I_D (at $V_{GS} = -10V$) -4.6A ● $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 50mΩ ● $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 85mΩ ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	 <p>Schematic diagram</p>  <p>SOT-23-6L</p>
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Ordering Information			
Device	Package	Marking	Packaging
G500P03LL	SOT-23-6L	G500P03	3000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ C$, unless otherwise noted				
Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	-30	V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	-4.6	A
	$T_C = 100^\circ C$		-2.9	
Pulsed Drain Current	(note1)	I_{DM}	-18.4	A
Gate-Source Voltage		V_{GS}	± 20	V
Power Dissipation		P_D	1.4	W
Single pulse avalanche energy	(note2)	E_{AS}	14	mJ
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 To 150	°C

Thermal Resistance				
Parameter		Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient, $t \leq 10s$		R_{thJA}	89	°C/W

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = -30\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 20\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-1.0	-1.7	-2.0	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -4\text{A}$	--	40	50	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -3\text{A}$	--	70	85	
Forward Transconductance	g_{FS}	$V_{\text{DS}} = -5\text{V}, I_D = -4\text{A}$	--	5	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = -15\text{V}, f = 1.0\text{MHz}$	--	620	--	pF
Output Capacitance	C_{oss}		--	85	--	
Reverse Transfer Capacitance	C_{rss}		--	75	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = -15\text{V}, I_D = -4\text{A}, V_{\text{GS}} = -10\text{V}$	--	13	--	nC
Gate-Source Charge	Q_{gs}		--	2.9	--	
Gate-Drain Charge	Q_{gd}		--	2.7	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = -15\text{V}, I_D = -4\text{A}, R_G = 3\Omega$	--	9	--	ns
Turn-on Rise Time	t_r		--	5	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	27	--	
Turn-off Fall Time	t_f		--	13	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_s	$T_C = 25^\circ\text{C}$	--	--	-4.6	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = -4\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	-1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = -4\text{A}, V_{\text{GS}} = 0\text{V}$ $dI/dt = -100\text{A/us}$	--	11	--	nC
Reverse Recovery Time	T_{rr}		--	5.3	--	ns

Notes

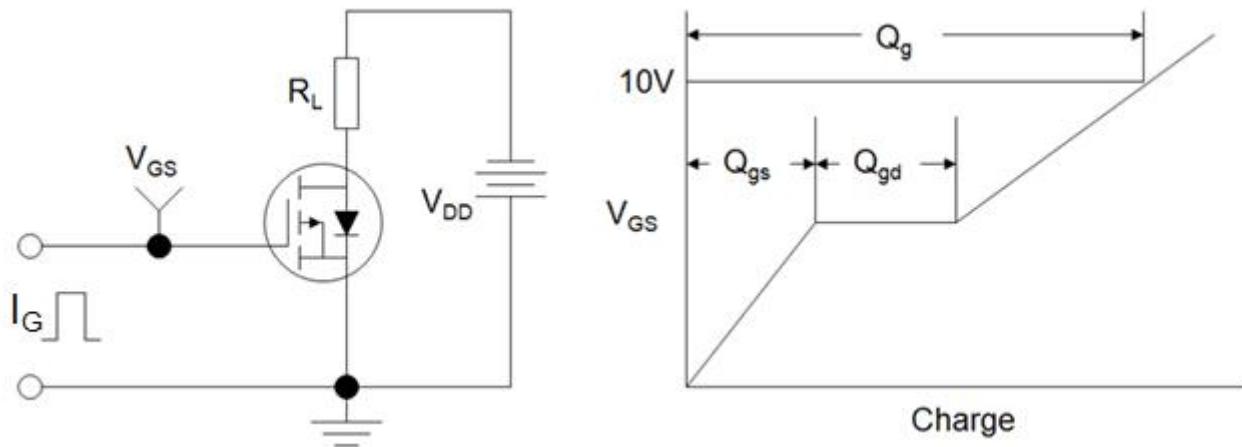
1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : $T_J=25^\circ\text{C}$, $V_{\text{DD}}=-30\text{V}$, $V_{\text{GS}}=-10\text{V}$, $L=0.5\text{mH}$, $R_g=25\Omega$

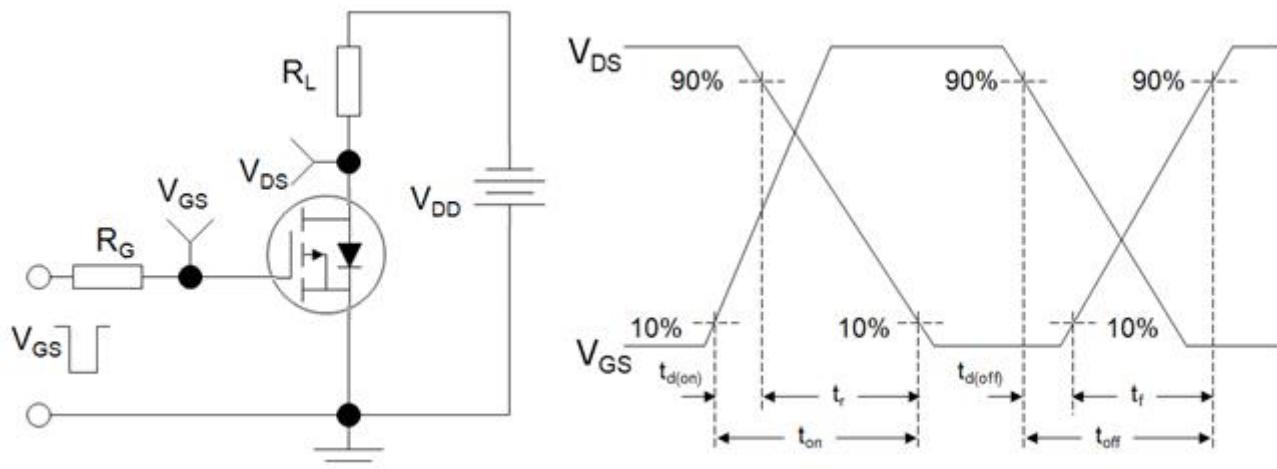
The table shows the minimum avalanche energy, which is 39mJ when the device is tested until failure

3. Identical low side and high side switch with identical R_g

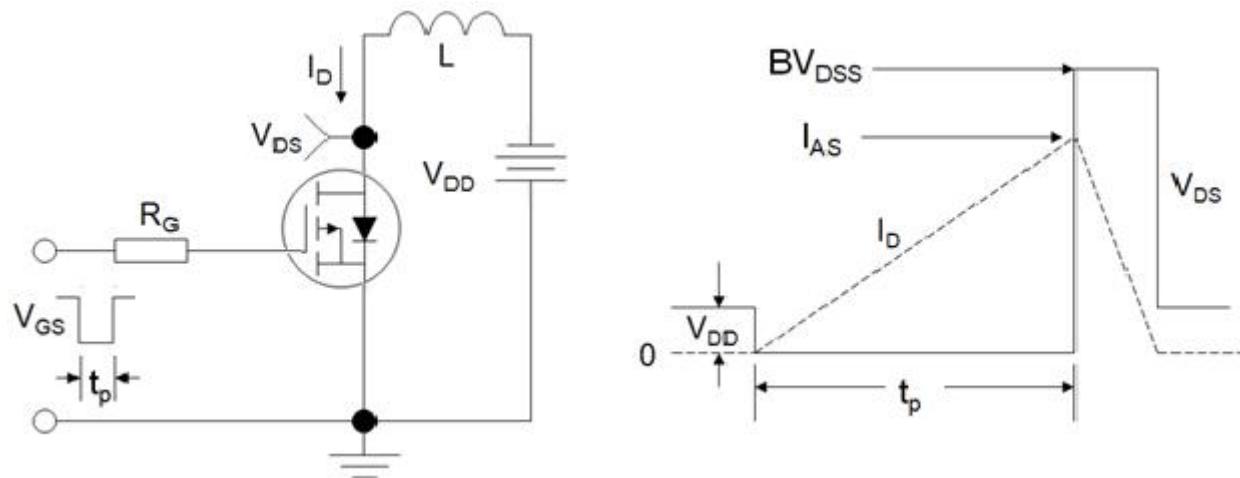
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

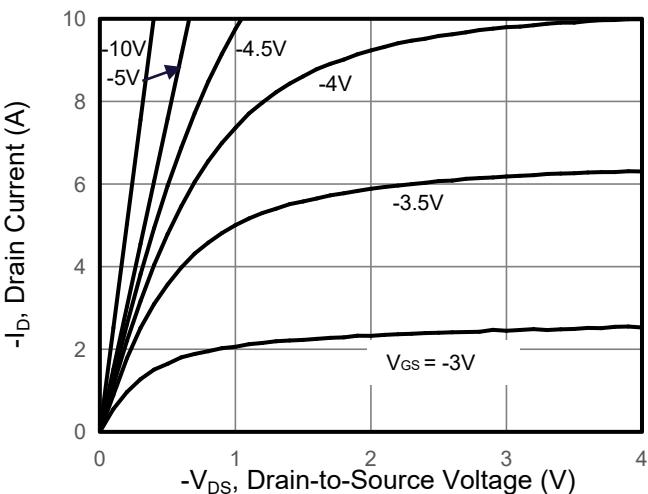


Figure 2. Transfer Characteristics

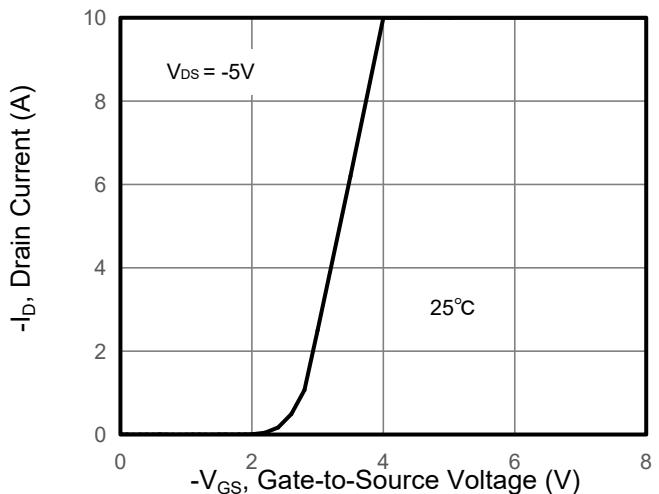


Figure 3. Drain Source On Resistance

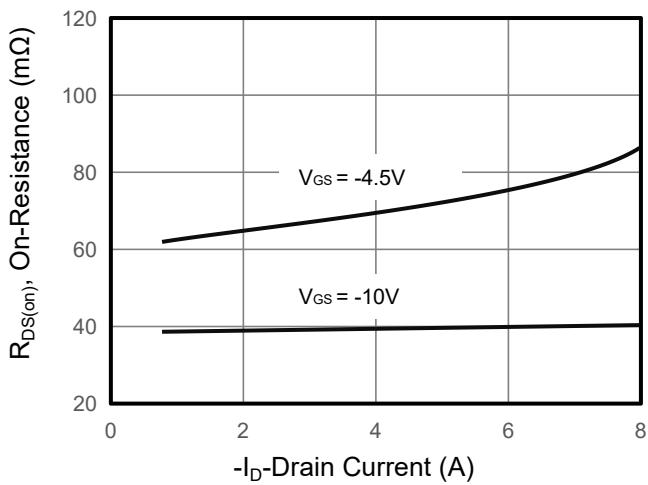


Figure 4. Gate Charge

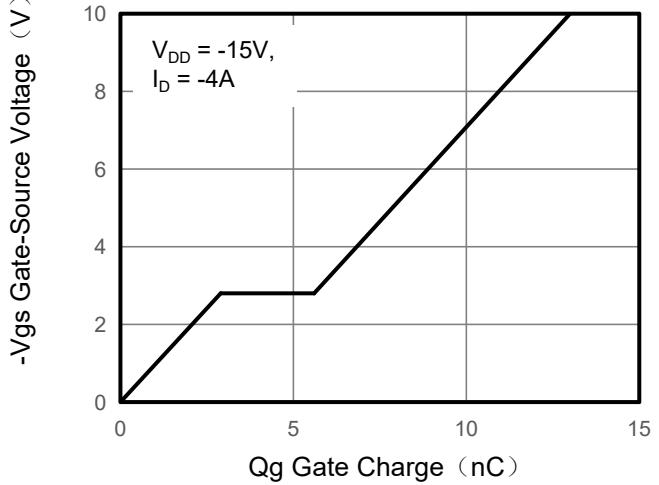


Figure 5. Capacitance

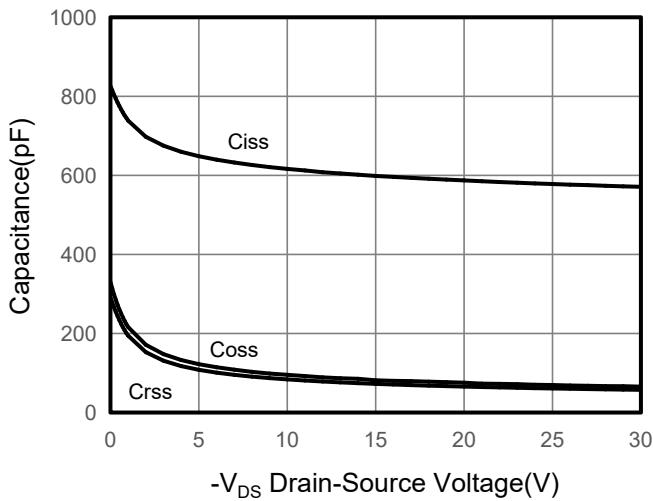
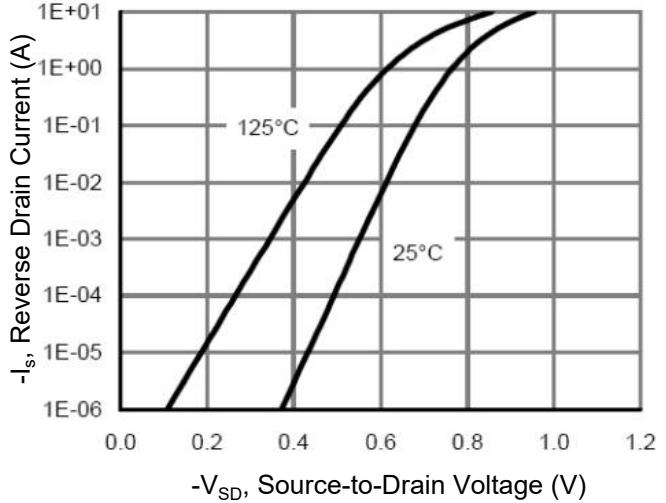


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

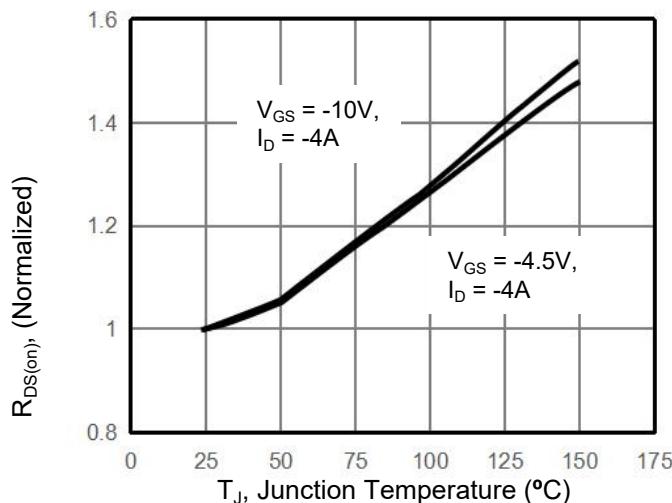


Figure 8. Safe Operation Area

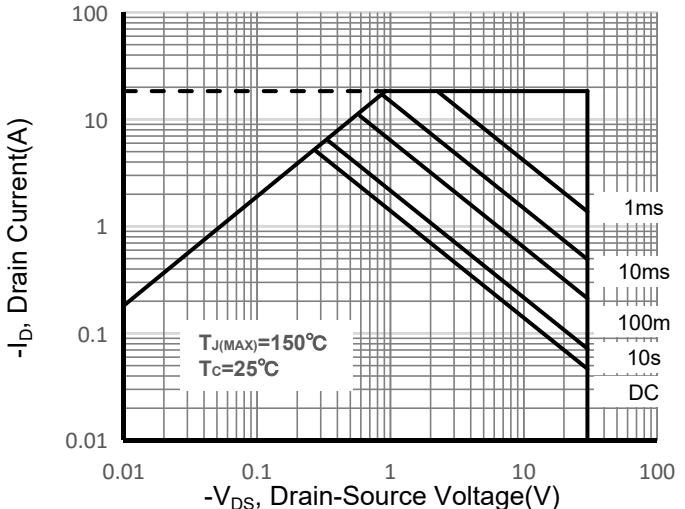


Figure 9. Maximum Continuous Drain Current vs Case Temperature

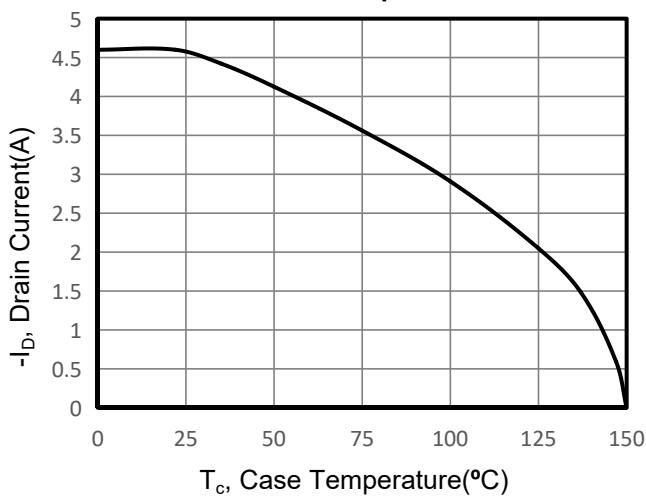
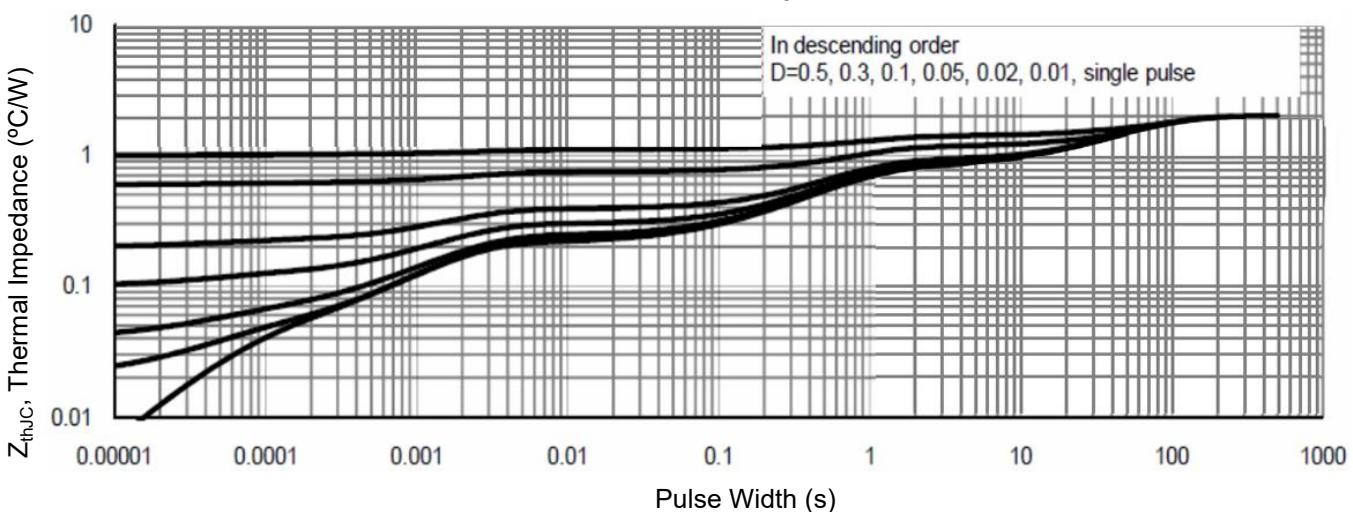


Figure 10. Normalized Maximum Transient Thermal Impedance



SOT-23-6L Package Information